## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6313215

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
SHO SAWADA	08/20/2020
HIDENORI SUZUKI	08/11/2020
EIJU KATSURAGI	08/17/2020
SHINTAROU INOUE	09/08/2020
HIROKI FUJII	07/28/2020

### **RECEIVING PARTY DATA**

Name:	HITACHI, LTD.
Street Address:	6-6, MARUNOUCHI 1-CHOME, CHIYODA-KU,
City:	TOKYO
State/Country:	JAPAN
Postal Code:	100-8280

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17029297

### **CORRESPONDENCE DATA**

**Fax Number:** (703)684-1157

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 703-684-1120

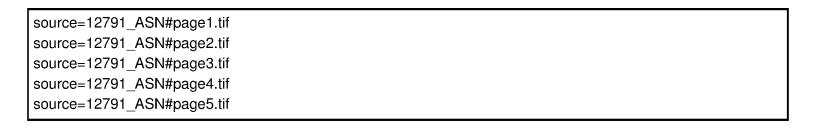
Email: svannarath@mmiplaw.com
Correspondent Name: MATTINGLY & MALUR, PC
Address Line 1: 1800 DIAGONAL ROAD

Address Line 2: SUITE 210

Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	WL-12791
NAME OF SUBMITTER:	SHRINATH MALUR
SIGNATURE:	/Shrinath Malur/
DATE SIGNED:	09/23/2020

Total Attachments: 5



(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me by Hitachi, Ltd.,

a corporation organized under the laws of Japan,

located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo 100-8280 Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd.,

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

### STORAGE SYSTEM AND REBUILDING METHOD FOR STORAGE SYSTEM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi, Ltd.

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)

	, (	発明者フルネームサイ	イン)		名目)	
1)	Sho	Sawada	Sho SAWADA	August	20 , 2020	_
2) _			Hidenori SUZUKI			
3) _			Eiju KATSURAGI			
4) _		··.	Shintarou INOUE			
			•			
						_
		,				-
8) _		``				_

PATENT REEL: 053856 FRAME: 0823

Date Signed

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	INVENTOR(S) (発明者フルネームサイン)		Date Signed (署名II)
1) .		Sho SAWADA	
2)	Hidenori Suzuki	Hidenori SUZUKI	August 11,2020
3)		Eiju KATSURAGI	
4)		Shintarou INOUE	
5)		Hiroki FUJII	
6) _			
7) <sub>-</sub> 8)			

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1) _		Sho SAWADA		
2) _		Hidenori SUZUKI		
3) _	/Eiju Katsuragi/	Eiju KATSURAGI	08/17/2020	
4) _		Shintarou INOUE		
5) _		Hiroki FUJII		
6) _				
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1)		Sho SAWADA		
2)		Hidenori SUZUKI		
3)		Eiju KATSURAGI		
4)	Shintarou Inoue	Shintarou INOUE	September 8,202	0
5)		Hiroki FUJII		
6)				
7)				
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2) _	Hidenori SUZUKI	
3) _	Eiju KATSURAGI	
4) _	Shintarou INOUE	
5) _	/Hiroki Fujii/ Hiroki FUJII	July 28th, 2020
6) _		
7) _		
8) _		

PATENT REEL: 053856 FRAME: 0827

RECORDED: 09/23/2020